

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
Motohiro Kawahito		09/10/2004
RECEIVING PARTY DATA		
Name:	International Business Machines Corporation	
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State/Country:	NEW YORK	
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PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	10940541	
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NAME OF SUBMITTER:	Richard Lau	
Total Attachments: 1 source=Assignment JP920030208US1#page1.tif		

CH \$40.00 10940541

ASSIGNMENT

Whereas, I,

INVENTOR (1) Motohiro Kawahito of Kanagawa-ken
AND CITY Japan

have invented certain improvements in

TITLE OPTIMIZING COMPILER

DATE THAT and executed, a United States patent application therefor on
DECLARATION
WAS SIGNED (1) Sep. / 10 / 2004.

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and the invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and I hereby agree that IBM may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and Sealed

CITY (1) at Yamato
DATE on Sep. / 19 2004 ,
(Motohiro Kawahito) Inventor
FIRST NAME MIDDLE INITIAL LAST NAME

PATENT